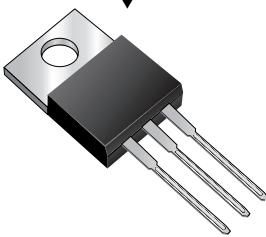




MBR1090CT thru MBR100CT

New Product

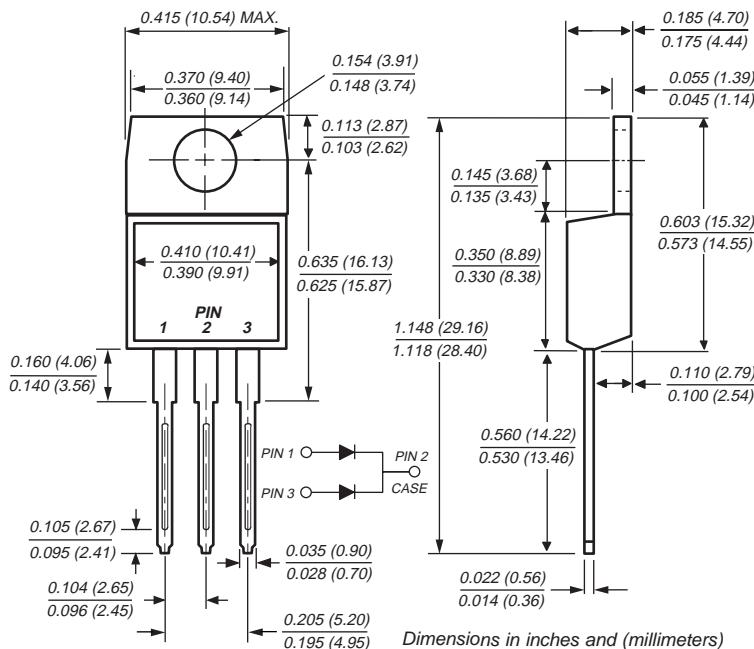
Vishay Semiconductors
formerly General Semiconductor



Dual High-Voltage Schottky Rectifiers

Reverse Voltage 90 to 100V
Forward Current 10A

TO-220AB



Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
 - Dual rectifier construction, positive center tap
 - Metal silicon junction, majority carrier conduction
 - Low power loss, high efficiency
 - Guardring for overvoltage protection
 - For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Mechanical Data

Case: JEDEC TO-220AB molded plastic body over passivated chips

Terminals: Plated leads, solderable per MIL-STD-750, Method 2026
High temperature soldering guaranteed:
250°C/10 seconds, 0.25" (6.35mm) from case

Polarity: As marked

Mounting Position: Any

Mounting Torque: 10 in-lbs maximum

Weight: 0.08 oz / 2.24 g

Maximum Ratings and Thermal Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	MBR1090CT	MBR10100CT	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	90	100	V
Working peak reverse voltage	V _{RWM}	90	100	V
Maximum DC blocking voltage	V _{DC}	90	100	V
Maximum average forward rectified current at T _C = 105°C	Total device Per leg	I _{F(AV)}	10 5	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) per leg	I _{FSM}		120	A
Peak repetitive reverse current per leg at t _p = 2μs, 1KHz	I _{RRM}		0.5	A
Voltage rate of change (rated V _R)	dV/dt		10,000	V/μs
Typical thermal resistance per leg	R _{θJC}		4.4	°C/W
Operating junction and storage temperature range	T _J , T _{STG}		-65 to +150	°C

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	MBR1090CT	MBR10100CT	Unit
Maximum instantaneous forward voltage per leg ⁽⁴⁾	V_F	0.75 0.85		V
Maximum reverse current per leg at working peak reverse voltage ⁽⁴⁾	I_R	100 6.0		μA mA

Notes:

- (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset
- (2) Clip mounting (on case), where leads do overlap heatsink
- (3) Screw mounting with 4-40 screw, where washer diameter is ≤ 4.9 mm (0.19")
- (4) Pulse test: 300µs pulse width, 1% duty cycle

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Ratings and Characteristic Curves

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 – Forward Current Derating Curve

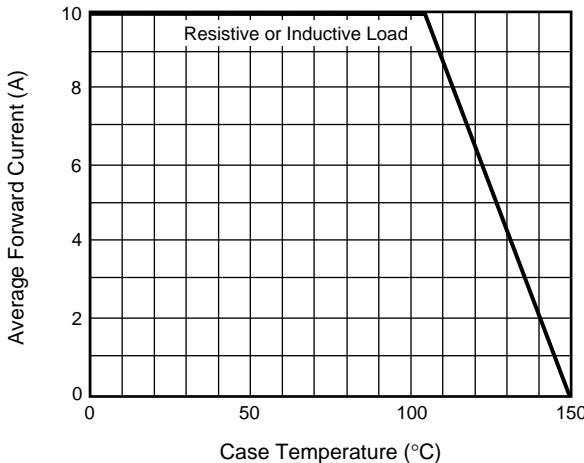


Fig. 3 – Typical Instantaneous Forward Characteristics Per Leg

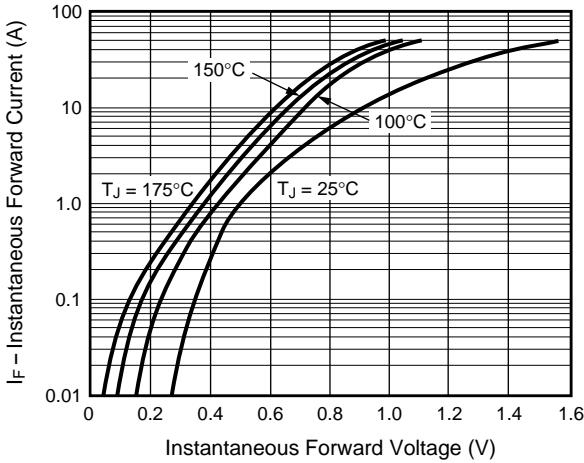


Fig. 5 – Typical Transient Thermal Impedance Per Leg

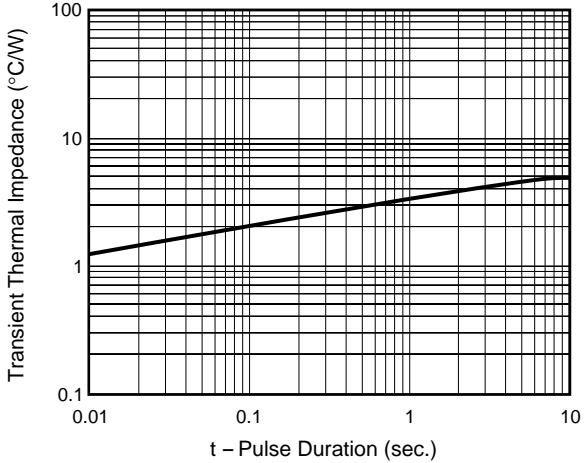


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current Per Leg

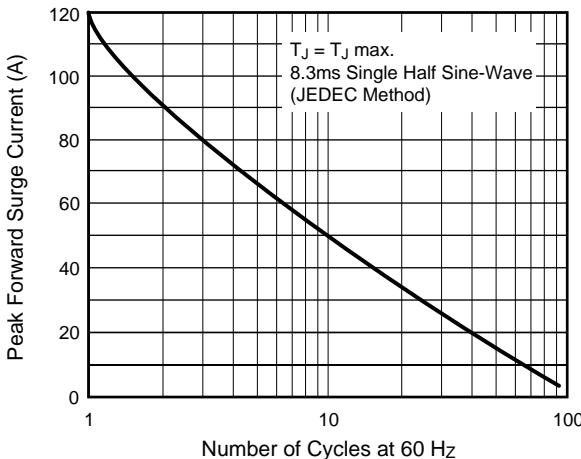


Fig. 4 – Typical Reverse Characteristics Per Leg

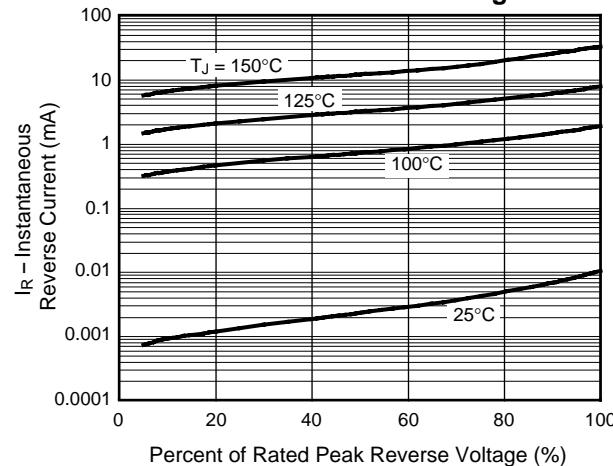


Fig. 6 – Typical Junction Capacitance Per Leg

